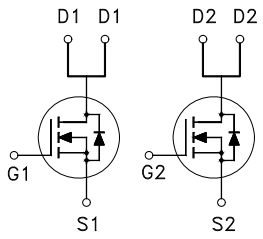
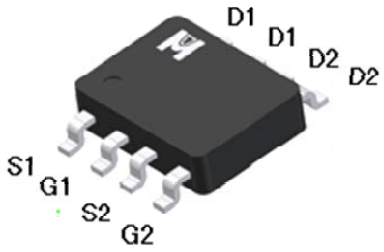
Dual N-Channel Logic Level Enhancement Mode Field Effect Transistor

Product Summary:

BV_{DSS}	20V
$R_{DSON\ (MAX.)}$	14.8mΩ
I_D	6A





UIS 100% Tested

Pb-Free Lead Plating & Halogen Free

GP
GREEN PRODUCT

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNIT
Gate-Source Voltage		V_{GS}	±12	V
Continuous Drain Current	T_A = 25 °C	I_D	6	A
	T_A = 100 °C		4	
Pulsed Drain Current[1]		I_{DM}	24	
Avalanche Current		I_{AS}	10	
Avalanche Energy	L = 0.1mH, ID=10A, RG=25Ω	E_{AS}	5	mJ
Repetitive Avalanche Energy[2]	L = 0.05mH	E_{AR}	2.5	
Power Dissipation	T_A = 25 °C	P_D	2	W
	T_A = 100 °C		0.8	
Operating Junction & Storage Temperature Range		T_j, T_{stg}	-55 to 150	°C

100% UIS testing in condition of V_D=10V, L=0.1mH, V_G=4.5V, I_L=6A, Rated V_{DS}=20V N-CH

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNIT
Junction-to-Case	$R_{\theta JC}$		25	°C / W
Junction-to-Ambient[3]	$R_{\theta JA}$		62.5	

[1]Pulse width limited by maximum junction temperature.

[2]Duty cycle ≤ 1%

[3]62.5°C / W when mounted on a 1 in^2 pad of 2 oz copper.

ELECTRICAL CHARACTERISTICS (T_A = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D = 250μA	20			V
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250μA	0.45	0.8	1.2	
Gate-Body Leakage	I_{GSS}	V_{DS} = 0V, V_{GS} = ±12V			±100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 16V, V_{GS} = 0V			1	μA
		V_{DS} = 16V, V_{GS} = 0V, T_J = 125 °C			25	
On-State Drain Current[1]	$I_{D(ON)}$	V_{DS} = 5V, V_{GS} = 4.5V	6			A
Drain-Source On-State Resistance[1]	$R_{DS(ON)}$	V_{GS} = 4.5V, I_D = 6A		13	14.8	mΩ
		V_{GS} = 2.5V, I_D = 5A		19	23	
Forward Transconductance[1]	g_{fs}	V_{DS} = 5V, I_D = 6A		8		S
DYNAMIC						
Input Capacitance	C_{iss}	V_{GS} = 0V, V_{DS} = 10V, f = 1MHz		700		pF
Output Capacitance	C_{oss}			208		
Reverse Transfer Capacitance	C_{rss}			187		
Total Gate Charge[1,2]	Q_g	V_{DS} = 10V, V_{GS} = 4.5V, I_D = 6A		10		nC
Gate-Source Charge[1,2]	Q_{gs}			1.8		
Gate-Drain Charge[1,2]	Q_{gd}			3.7		
Turn-On Delay Time[1,2]	$t_{d(on)}$	V_{DS} = 10V, I_D = 1A, V_{GS} = 4.5V, R_{GS} = 6Ω		15		nS
Rise Time[1,2]	t_r			20		
Turn-Off Delay Time[1,2]	$t_{d(off)}$			30		
Fall Time[1,2]	t_f			20		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_C = 25 °C)						
Continuous Current	I_S				2.3	A
Pulsed Current[3]	I_{SM}				9.2	
Forward Voltage[1]	V_{SD}	I_F = I_S, V_{GS} = 0V			1.2	V

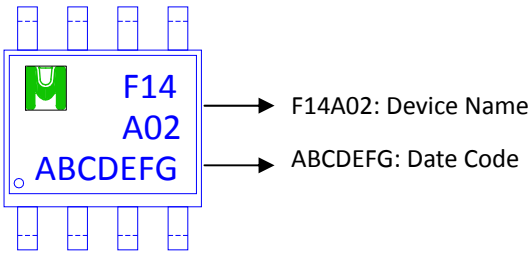
[1]Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

[2]Independent of operating temperature.

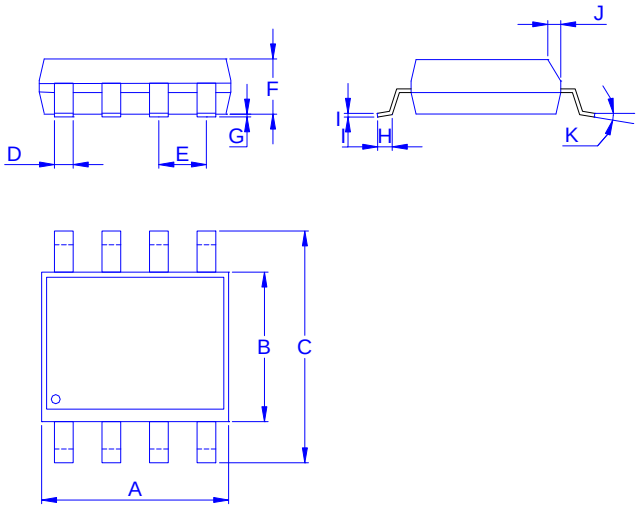
[3]Pulse width limited by maximum junction temperature.

Ordering & Marking Information:

Device Name: EMF14A02G for SOP-8

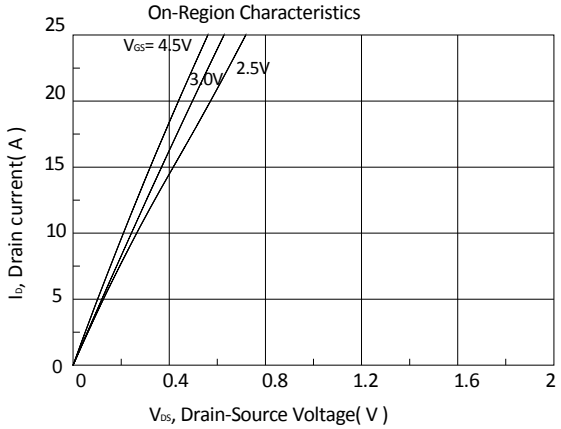


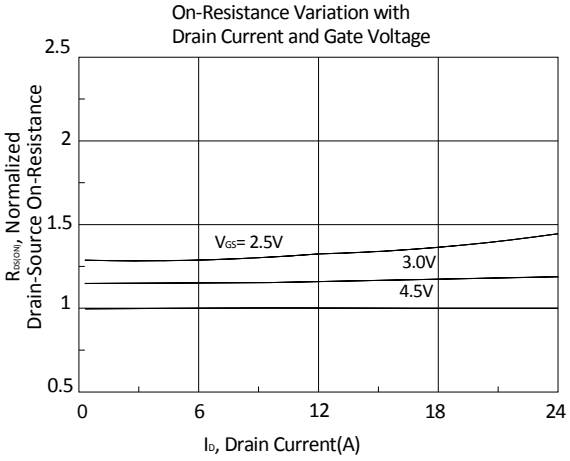
Outline Drawing

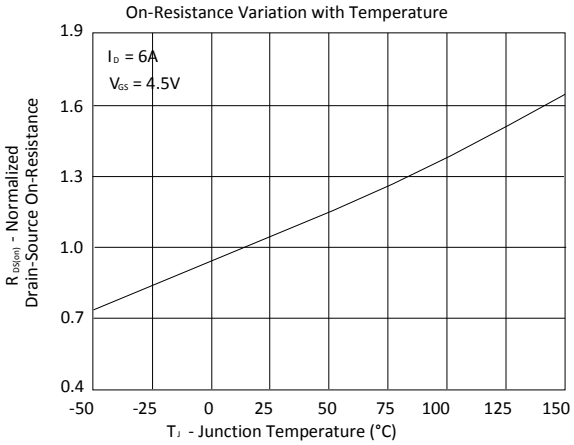


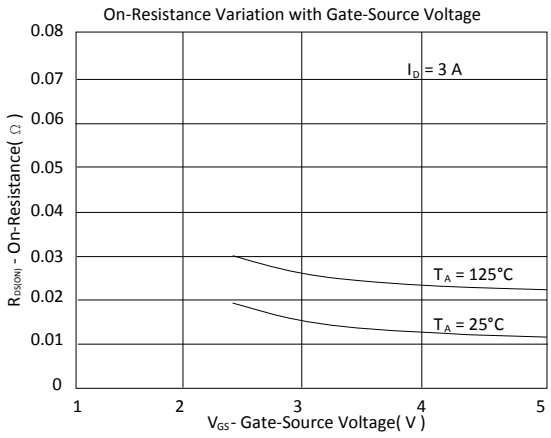
Dimension in mm

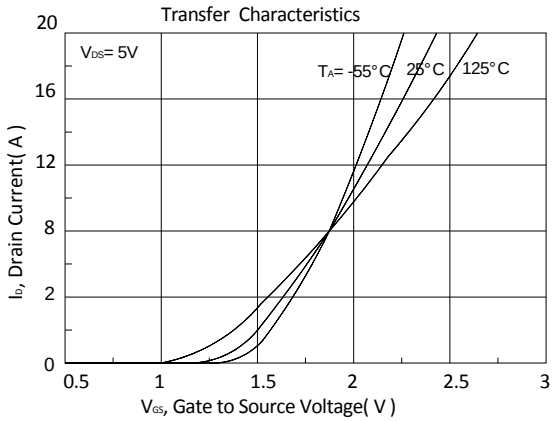
Dimension	A	B	C	D	E	F	G	H	I	J	K
Min.	4.70	3.70	5.80	0.33		1.20	0.08	0.40	0.19	0.25	0°
Typ.					1.27						
Max.	5.10	4.10	6.20	0.51		1.62	0.28	0.83	0.26	0.50	8°

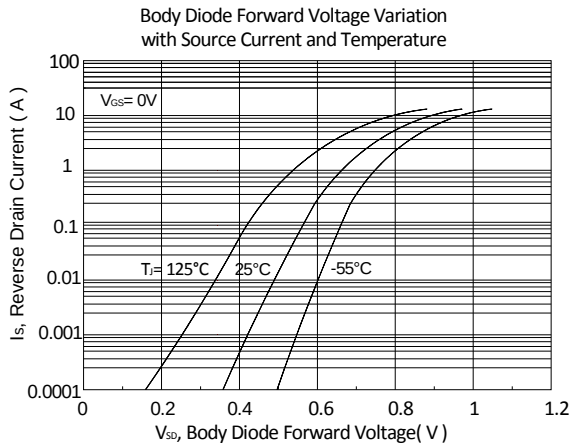

On-Region Characteristics
VGS= 4.5V
3.0V
2.5V
ID, Drain current(A)
VDS, Drain-Source Voltage(V)


On-Resistance Variation with
Drain Current and Gate Voltage
VGS= 2.5V
3.0V
4.5V
RDS(ON), Normalized
Drain-Source On-Resistance
ID, Drain Current(A)

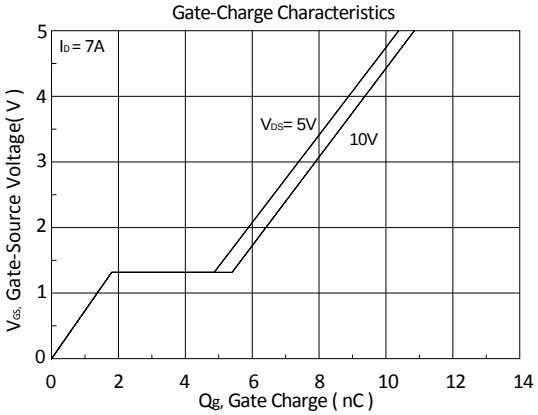

On-Resistance Variation with Temperature
ID = 6A
VGS = 4.5V
RDS(on) - Normalized
Drain-Source On-Resistance
TJ - Junction Temperature (°C)


On-Resistance Variation with Gate-Source Voltage
ID = 3 A
TA = 125°C
TA = 25°C
RDS(ON) - On-Resistance(Ω)
VGS - Gate-Source Voltage(V)

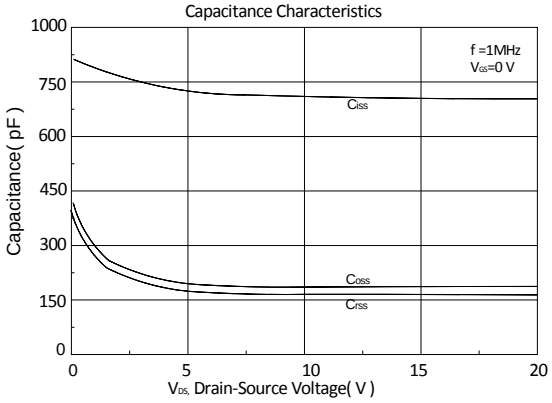

Transfer Characteristics
VDS= 5V
TA= -55°C
25°C
125°C
ID, Drain Current(A)
VGS, Gate to Source Voltage(V)


Body Diode Forward Voltage Variation
with Source Current and Temperature
VGS= 0V
TJ= 125°C
25°C
-55°C
IS, Reverse Drain Current (A)
VSD, Body Diode Forward Voltage(V)

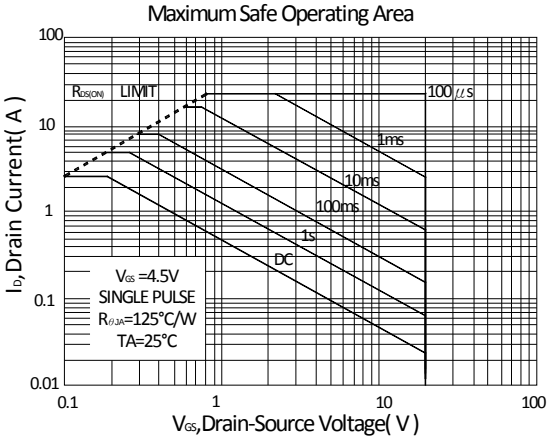
Gate-Charge Characteristics



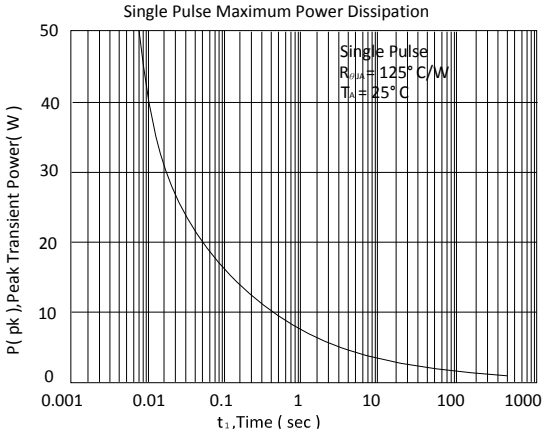
Capacitance Characteristics



Maximum Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve